

DATA SHEET

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74ABT543A

Octal latched transceiver
with dual enable (3-State)

Product specification
Supersedes data of 1995 Apr 19
IC23 Data Handbook

1998 Sep 24

Octal latched transceiver with dual enable (3-State)

74ABT543A

FEATURES

- Combines 74ABT245 and 74ABT373 type functions in one device
- 8-bit octal transceiver with D-type latch
- Back-to-back registers for storage
- Separate controls for data flow in each direction
- Output capability: +64mA/-32mA
- Live insertion/extraction permitted
- Power-up 3-State
- Power-up reset
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model

DESCRIPTION

The 74ABT543A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT543A Octal Registered Transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate Latch Enable (\overline{LEAB} , \overline{LEBA}) and Output Enable (\overline{OEAB} , \overline{OEBA}) inputs are provided for each register to permit independent control of data transfer in either direction. The outputs are guaranteed to sink 64mA.

FUNCTIONAL DESCRIPTION

The 74ABT543A contains two sets of eight D-type latches, with separate control pins for each set. Using data flow from A to B as an example, when the A-to-B Enable (\overline{EAB}) input and the A-to-B Latch Enable (\overline{LEAB}) input are Low the A-to-B path is transparent. A subsequent Low-to-High transition of the \overline{LEAB} signal puts the A data into the latches where it is stored and the B outputs no longer change with the A inputs. With \overline{EAB} and \overline{OEAB} both Low, the 3-State B output buffers are active and display the data present at the outputs of the A latches.

Control of data flow from B to A is similar, but using the \overline{EBA} , \overline{LEBA} , and \overline{OEBA} inputs.

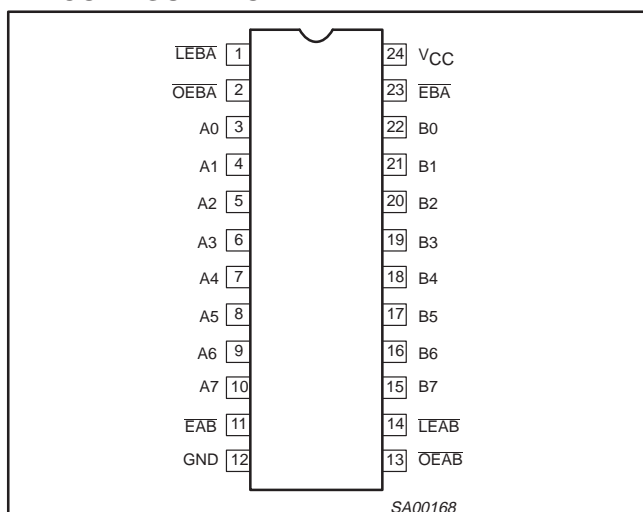
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|------------------------|---|--|------------|---------------|
| | | $T_{amb} = 25^{\circ}\text{C}$; GND = 0V | | |
| t_{PLH} t_{PHL} | Propagation delay An to Bn or Bn to An | $C_L = 50\text{pF}$; $V_{CC} = 5\text{V}$ | 2.9 3.6 | ns |
| C_{IN} | Input capacitance | $V_I = 0\text{V}$ or V_{CC} | 4 | pF |
| $C_{I/O}$ | I/O capacitance | Outputs disabled; $V_O = 0\text{V}$ or V_{CC} | 7 | pF |
| I_{CCZ} | Total supply current | Outputs disabled; $V_{CC} = 5.5\text{V}$ | 110 | μA |

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|-----------------------------|-------------------|-----------------------|---------------|------------|
| 24-Pin Plastic DIP | -40°C to +85°C | 74ABT543A N | 74ABT543A N | SOT222-1 |
| 24-Pin plastic SO | -40°C to +85°C | 74ABT543A D | 74ABT543A D | SOT137-1 |
| 24-Pin Plastic SSOP Type II | -40°C to +85°C | 74ABT543A DB | 74ABT543A DB | SOT340-1 |
| 24-Pin Plastic TSSOP Type I | -40°C to +85°C | 74ABT543A PW | 74ABT543A PW | SOT355-1 |

PIN CONFIGURATION



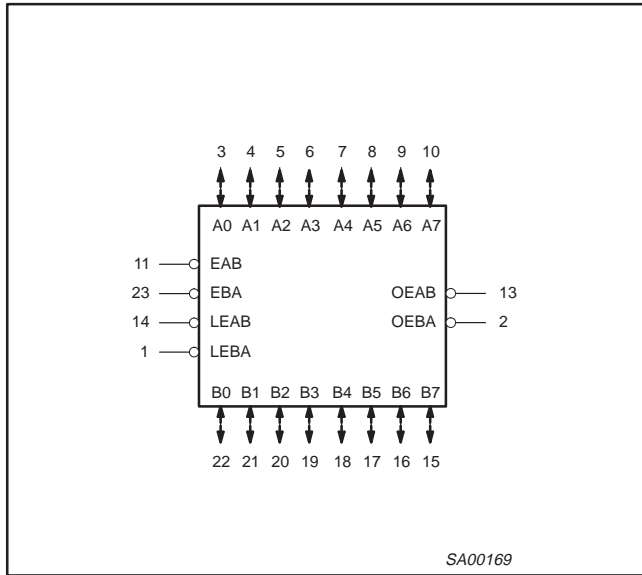
PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
|--------------------------------|---------------------------------------|--|
| 14, 1 | \overline{LEAB} / \overline{LEBA} | A to B / B to A Latch Enable input (active-Low) |
| 11, 23 | \overline{EAB} / \overline{EBA} | A to B / B to A Enable input (active-Low) |
| 13, 2 | \overline{OEAB} / \overline{OEBA} | A to B / B to A Output Enable input (active-Low) |
| 3, 4, 5, 6, 7, 8, 9, 10 | A0 – A7 | Port A, 3-State outputs |
| 22, 21, 20, 19, 18, 17, 16, 15 | B0 – B7 | Port B, 3-State outputs |
| 12 | GND | Ground (0V) |
| 24 | V_{CC} | Positive supply voltage |

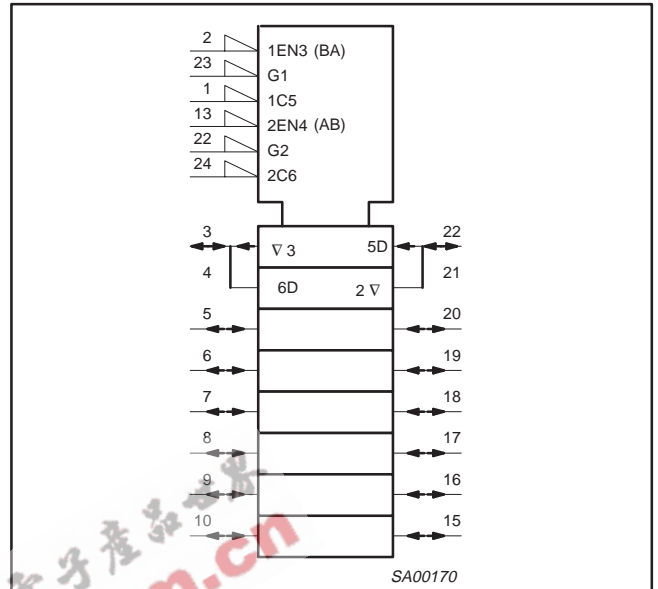
Octal latched transceiver with dual enable (3-State)

74ABT543A

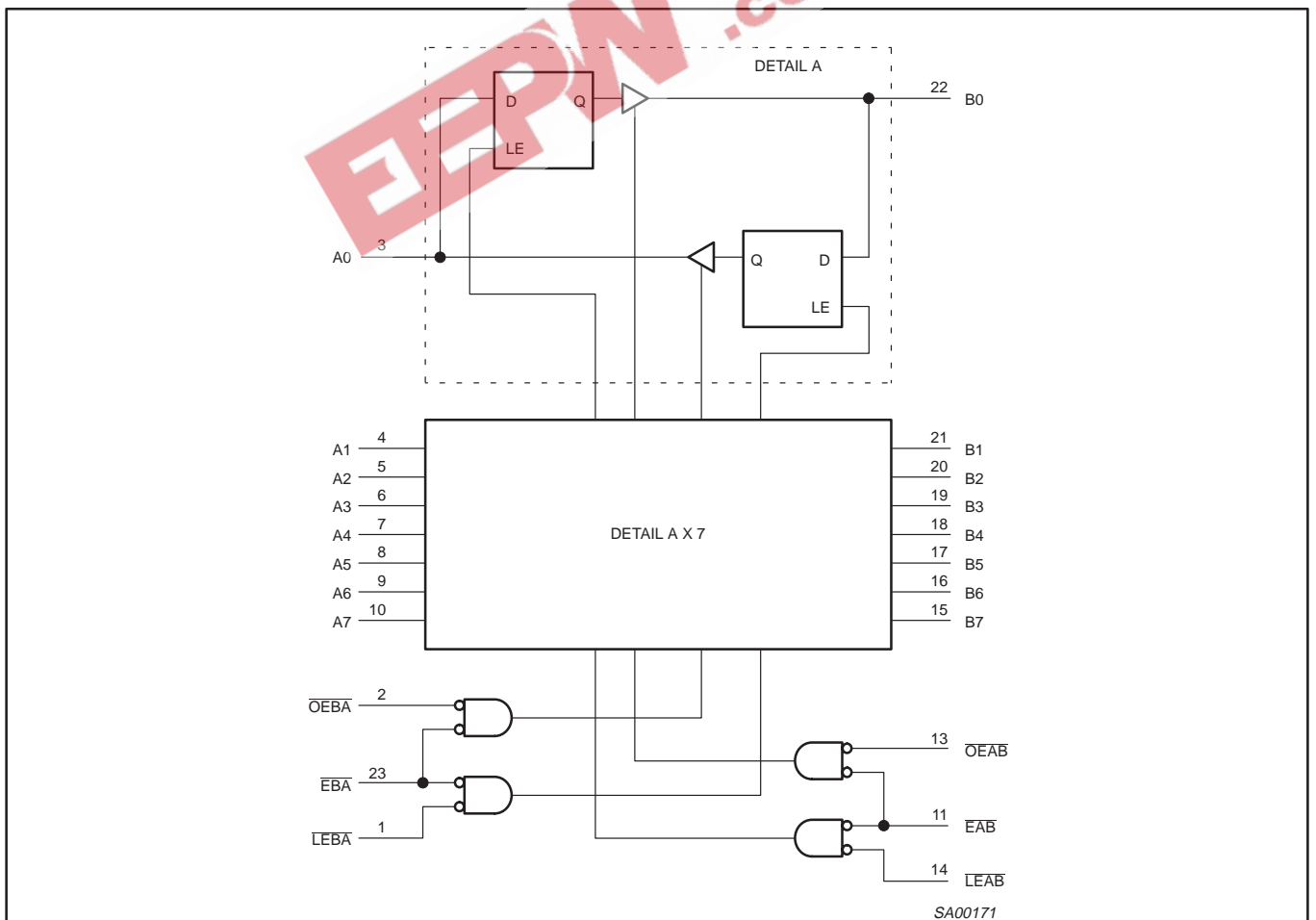
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



LOGIC DIAGRAM



Octal latched transceiver with dual enable (3-State)

74ABT543A

FUNCTION TABLE

| INPUTS | | | | OUTPUTS | STATUS |
|--------|-----|------|----------|----------|------------------|
| OEXX | EXX | LEXX | An or Bn | Bn or An | |
| H | X | X | X | Z | Disabled |
| X | H | X | X | Z | Disabled |
| L | ↑ | L | h | Z | Disabled + Latch |
| L | ↑ | L | l | Z | |
| L | L | ↑ | h | H | Latch + Display |
| L | L | ↑ | l | L | |
| L | L | L | H | H | Transparent |
| L | L | L | L | L | |
| L | L | H | X | NC | Hold |

H = High voltage level

h = High voltage level one set-up time prior to the Low-to-High transition of LEXX or EXX (XX = AB or BA)

L = Low voltage level

l = Low voltage level one set-up time prior to the Low-to-High transition of LEXX or EXX (XX = AB or BA)

X = Don't care

↑ = Low-to-High transition of LEXX or EXX (XX = AB or BA)

NC = No change

Z = High impedance or "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|------------------|--------------------------------|-----------------------------|--------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| I _{IK} | DC input diode current | V _I < 0 | -18 | mA |
| V _I | DC input voltage ³ | | -1.2 to +7.0 | V |
| I _{OK} | DC output diode current | V _O < 0 | -50 | mA |
| V _{OUT} | DC output voltage ³ | output in Off or High state | -0.5 to +5.5 | V |
| I _{OUT} | DC output current | output in Low state | 128 | mA |
| T _{stg} | Storage temperature range | | -65 to 150 | °C |

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS | | UNIT |
|------------------|--------------------------------------|--------|-----------------|------|
| | | Min | Max | |
| V _{CC} | DC supply voltage | 4.5 | 5.5 | V |
| V _I | Input voltage | 0 | V _{CC} | V |
| V _{IH} | High-level input voltage | 2.0 | | V |
| V _{IL} | Low-level input voltage | | 0.8 | V |
| I _{OH} | High-level output current | | -32 | mA |
| I _{OL} | Low-level output current | | 64 | mA |
| Δt/Δv | Input transition rise or fall rate | 0 | 10 | ns/V |
| T _{amb} | Operating free-air temperature range | -40 | +85 | °C |

Octal latched transceiver with dual enable (3-State)

74ABT543A

DC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | | TEST CONDITIONS | LIMITS | | | | | UNIT |
|------------------------------------|--|--------------|---|--------------------------|-------|------|-----------------------------------|------|------|
| | | | | T _{amb} = +25°C | | | T _{amb} = -40°C to +85°C | | |
| | | | | Min | Typ | Max | Min | Max | |
| V _{IK} | Input clamp voltage | | V _{CC} = 4.5V; I _{IK} = -18mA | | -0.9 | -1.2 | | -1.2 | V |
| V _{OH} | High-level output voltage | | V _{CC} = 4.5V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH} | 2.5 | 3.2 | | 2.5 | | V |
| | | | V _{CC} = 5.0V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH} | 3.0 | 3.7 | | 3.0 | | V |
| | | | V _{CC} = 4.5V; I _{OH} = -32mA; V _I = V _{IL} or V _{IH} | 2.0 | 2.3 | | 2.0 | | V |
| V _{OL} | Low-level output voltage | | V _{CC} = 4.5V; I _{OL} = 64mA; V _I = V _{IL} or V _{IH} | | 0.3 | 0.55 | | 0.55 | V |
| V _{RST} | Power-up output low voltage ³ | | V _{CC} = 5.5V; I _O = 1mA; V _I = GND or V _{CC} | | 0.13 | .55 | | .55 | V |
| I _I | Input leakage current | Control pins | V _{CC} = 5.5V; V _I = GND or 5.5V | | ±0.01 | ±1.0 | | ±1.0 | μA |
| | | Data pins | V _{CC} = 5.5V; V _I = GND or 5.5V | | ±5 | ±100 | | ±100 | μA |
| I _{OFF} | Power-off leakage current | | V _{CC} = 0.0V; V _O or V _I ≤ 4.5V | | ±5.0 | ±100 | | ±100 | μA |
| I _{PU/PD} | Power-up/down 3-State output current ⁴ | | V _{CC} = 2.1V; V _O = 0.5V; V _I = GND or V _{CC} ; V _{OE} = Don't care | | ±5.0 | ±50 | | ±50 | μA |
| I _{IH} + I _{OZH} | 3-State output High current | | V _{CC} = 5.5V; V _O = 2.7V; V _I = V _{IL} or V _{IH} | | 5.0 | 50 | | 50 | μA |
| I _{IL} + I _{OZL} | 3-State output Low current | | V _{CC} = 5.5V; V _O = 0.5V; V _I = V _{IL} or V _{IH} | | -5.0 | -50 | | -50 | μA |
| I _{CEX} | Output high leakage current | | V _{CC} = 5.5V; V _O = 5.5V; V _I = GND or V _{CC} | | 5.0 | 50 | | 50 | μA |
| I _O | Output current ¹ | | V _{CC} = 5.5V; V _O = 2.5V | -40 | -65 | -180 | -40 | -180 | mA |
| I _{CCH} | Quiescent supply current | | V _{CC} = 5.5V; Outputs High, V _I = GND or V _{CC} | | 110 | 250 | | 250 | μA |
| I _{CCL} | | | V _{CC} = 5.5V; Outputs Low, V _I = GND or V _{CC} | | 20 | 30 | | 30 | mA |
| I _{CCZ} | | | V _{CC} = 5.5V; Outputs 3-State; V _I = GND or V _{CC} | | 110 | 250 | | 250 | μA |
| ΔI _{CC} | Additional supply current per input pin ² | | V _{CC} = 5.5V; one input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V | | 0.3 | 1.5 | | 1.5 | mA |

NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input at 3.4V.
- For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
- This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10%, a transition time of up to 100μsec is permitted.

Octal latched transceiver with dual enable (3-State)

74ABT543A

AC CHARACTERISTICS

GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | | | UNIT |
|--------------------------------------|---|----------|--|------------|------------|--|------------|------|
| | | | $T_{\text{amb}} = +25^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V}$ | | | $T_{\text{amb}} = -40 \text{ to } +85^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$ | | |
| | | | Min | Typ | Max | Min | Max | |
| t_{PLH} t_{PHL} | Propagation delay An to Bn, Bn to An | 2 | 1.0 1.9 | 2.9 3.6 | 4.5 5.2 | 1.0 1.9 | 5.2 5.7 | ns |
| t_{PLH} t_{PHL} | Propagation delay LEBA to An, LEAB to Bn | 1 2 | 1.0 2.1 | 3.4 4.3 | 5.1 6.0 | 1.0 2.1 | 6.2 6.7 | ns |
| t_{PZH} t_{PZL} | Output enable time OEBA to An, OEAB to Bn | 4 5 | 1.0 2.0 | 3.2 4.3 | 5.1 5.9 | 1.0 2.0 | 6.2 6.6 | ns |
| t_{PHZ} t_{PLZ} | Output disable time OEBA to An, OEAB to Bn | 4 5 | 2.0 1.0 | 4.0 3.0 | 5.7 4.6 | 2.0 1.0 | 6.2 5.0 | ns |
| t_{PZH} t_{PZL} | Output enable time EBA to An, EAB to Bn | 4 5 | 1.0 2.0 | 3.4 4.4 | 5.1 6.1 | 1.0 2.0 | 6.2 6.8 | ns |
| t_{PHZ} t_{PLZ} | Output disable time EBA to An, EAB to Bn | 4 5 | 2.0 1.0 | 3.6 3.0 | 5.4 4.6 | 2.0 1.0 | 5.9 5.0 | ns |

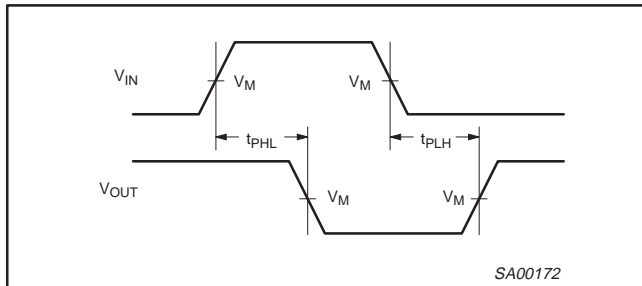
AC SETUP REQUIREMENTS

GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

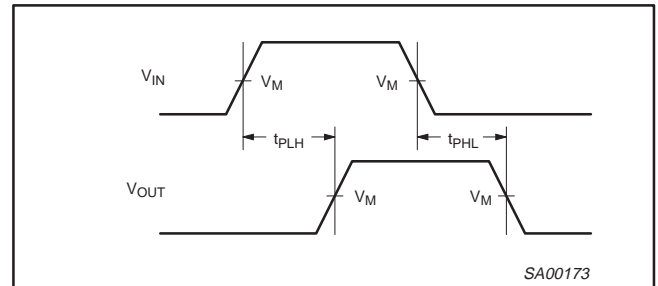
| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | UNIT |
|------------------------------------|--------------------------------------|----------|--|--------------|--|------|
| | | | $T_{\text{amb}} = +25^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V}$ | | $T_{\text{amb}} = -40 \text{ to } +85^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$ | |
| | | | Min | Typ | Min | |
| $t_s(\text{H})$ $t_s(\text{L})$ | Setup time An to LEAB, Bn to LEBA | 3 | 2.5 3.0 | 1.0 1.4 | 2.5 3.0 | ns |
| $t_h(\text{H})$ $t_h(\text{L})$ | Hold time An to LEAB, Bn to LEBA | 3 | 0.5 0.5 | -0.8 -0.6 | 0.5 0.5 | ns |
| $t_s(\text{H})$ $t_s(\text{L})$ | Setup time An to EAB, Bn to EBA | 3 | 3.5 3.0 | 1.3 1.4 | 3.5 3.0 | ns |
| $t_h(\text{H})$ $t_h(\text{L})$ | Hold time An to EAB, Bn to EBA | 3 | 0.5 0.5 | -0.8 -0.6 | 0.5 0.5 | ns |
| $t_w(\text{L})$ | Latch enable pulse width, Low | 3 | 3.5 | 1.0 | 3.5 | ns |

AC WAVEFORMS

$V_M = 1.5\text{V}$, $V_{\text{IN}} = \text{GND to } 3.0\text{V}$



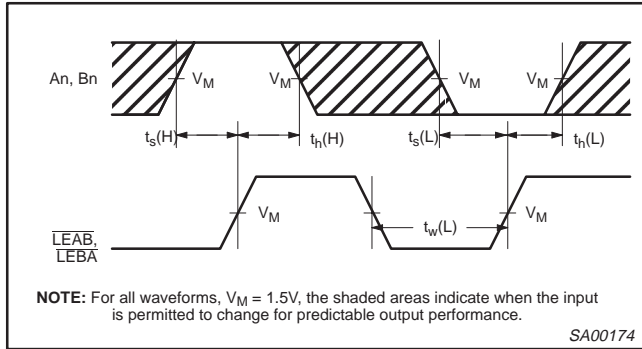
Waveform 1. Propagation Delay For Inverting Output



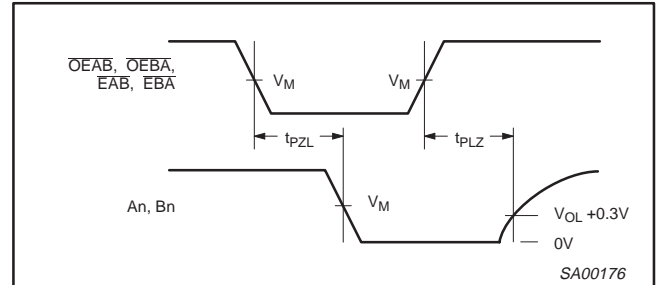
Waveform 2. Propagation Delay For Non-Inverting Output

Octal latched transceiver with dual enable (3-State)

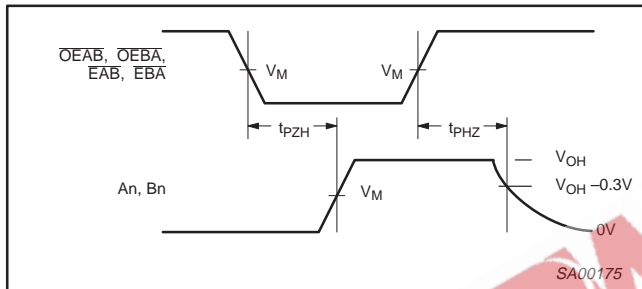
74ABT543A



Waveform 3. Data Setup and Hold Times And Latch Enable Pulse Width

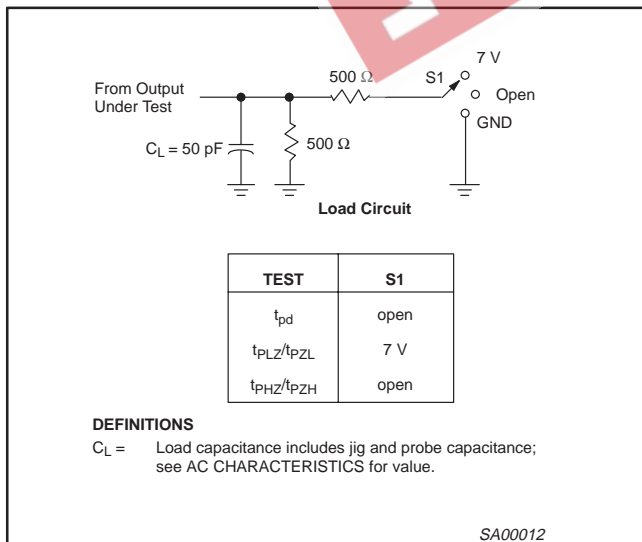


Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level



Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level

TEST CIRCUIT AND WAVEFORM

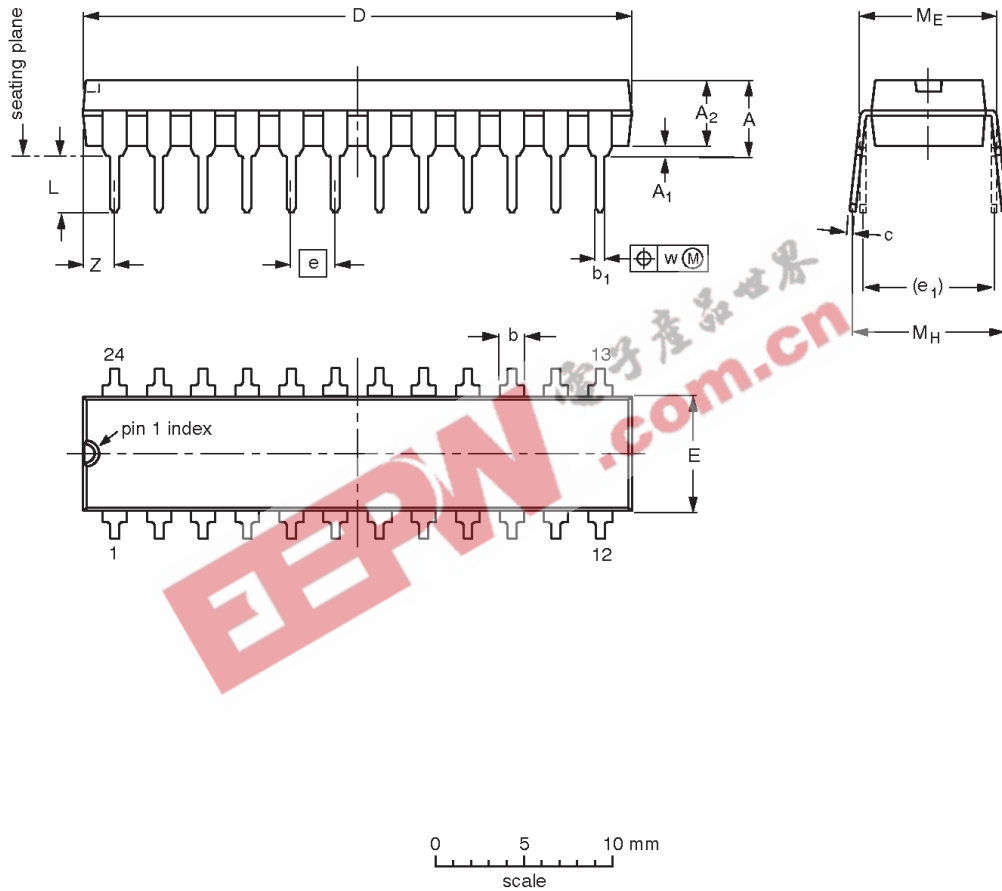


Octal latched transceiver with dual enable
(3-State)

74ABT543A

DIP24: plastic dual in-line package; 24 leads (300 mil)

SOT222-1



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | A max. | A1 min. | A2 max. | b | b1 | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e1 | L | ME | MH | w | Z ⁽¹⁾ max. |
|--------|--------|---------|---------|----------------|----------------|----------------|------------------|------------------|-------|-------|----------------|--------------|----------------|------|-----------------------|
| mm | 4.70 | 0.38 | 3.94 | 1.63 1.14 | 0.56 0.43 | 0.36 0.25 | 31.9 31.5 | 6.73 6.48 | 2.54 | 7.62 | 3.51 3.05 | 8.13 7.62 | 10.03 7.62 | 0.25 | 2.05 |
| inches | 0.185 | 0.015 | 0.155 | 0.064 0.045 | 0.022 0.017 | 0.014 0.010 | 1.256 1.240 | 0.265 0.255 | 0.100 | 0.300 | 0.138 0.120 | 0.32 0.30 | 0.395 0.300 | 0.01 | 0.081 |

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

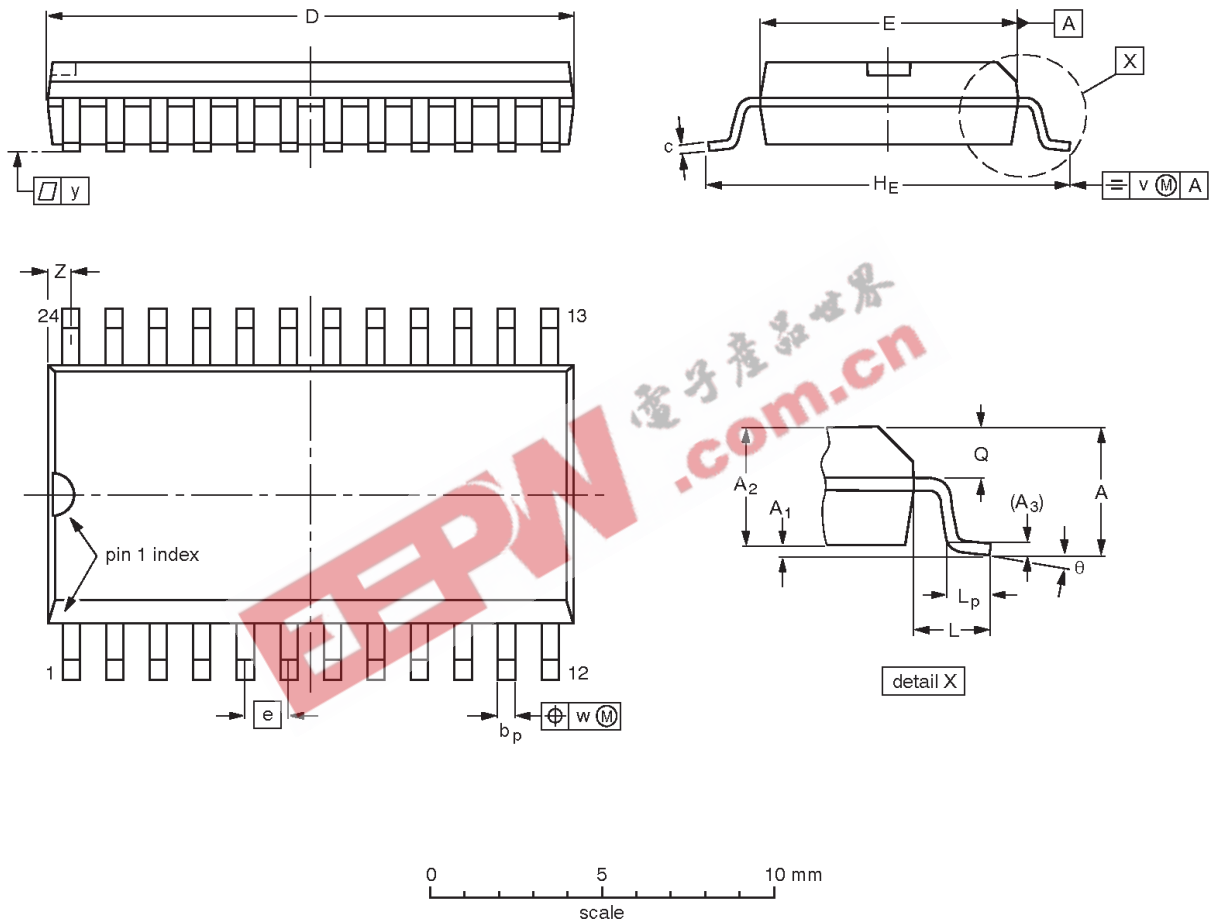
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT222-1 | | MS-001AF | | | | 95-03-11 |

Octal latched transceiver with dual enable
(3-State)

74ABT543A

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|--------|--------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 2.65 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 15.6 15.2 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.61 0.60 | 0.30 0.29 | 0.050 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

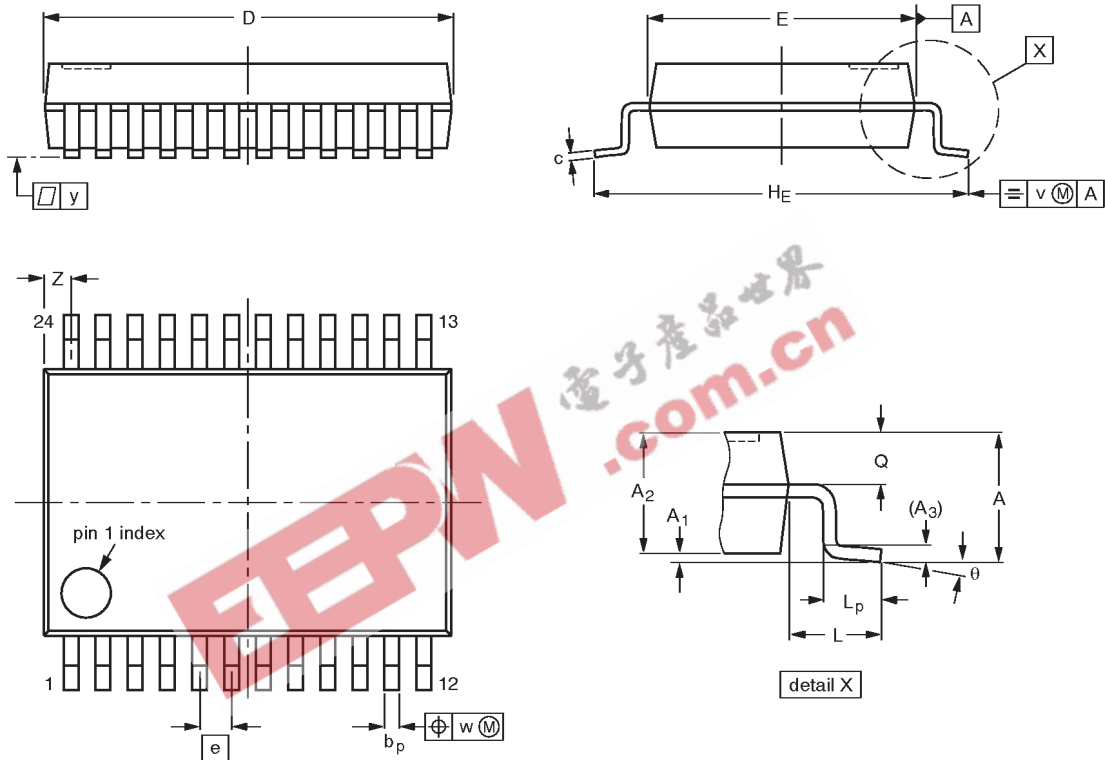
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT137-1 | 075E05 | MS-013AD | | | | 95-01-24 97-05-22 |

Octal latched transceiver with dual enable
(3-State)

74ABT543A

SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 8.4 8.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.8 0.4 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

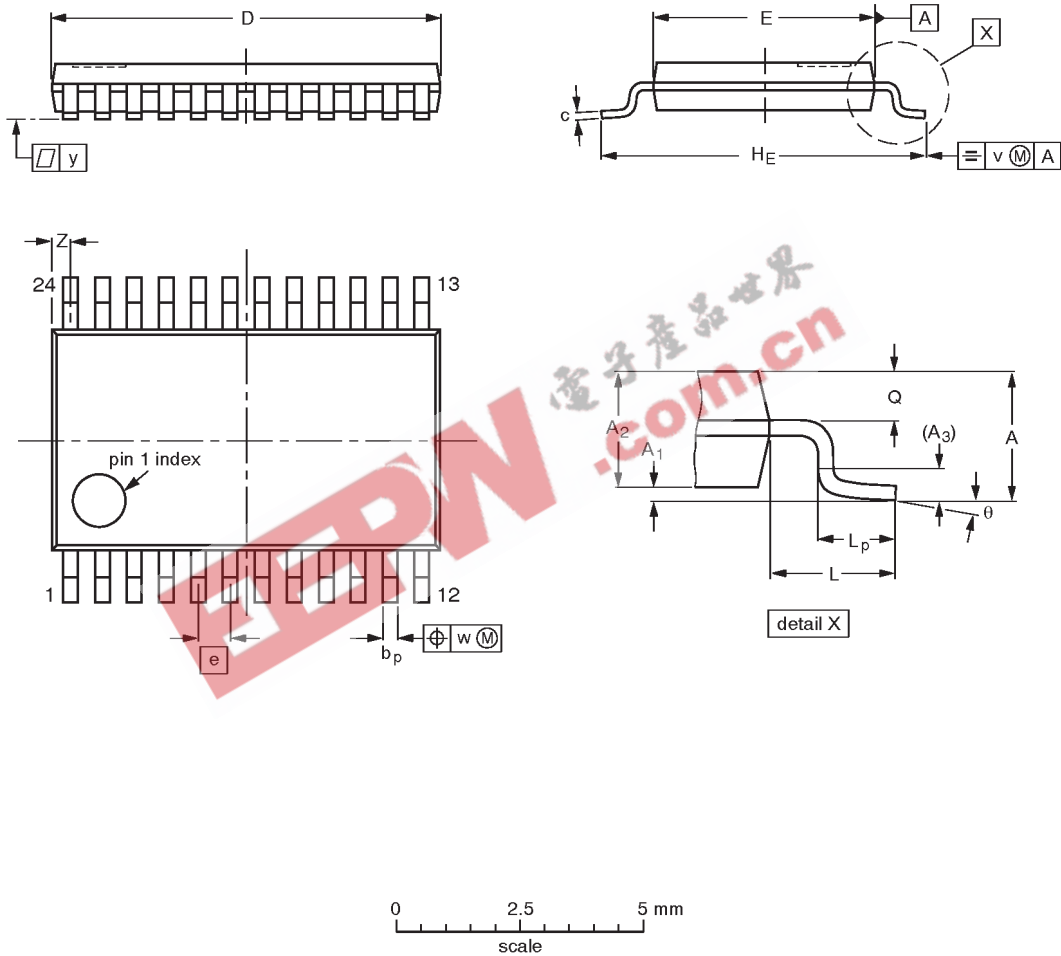
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT340-1 | | MO-150AG | | | | 93-09-08 95-02-04 |

Octal latched transceiver with dual enable
(3-State)

74ABT543A

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|-----|----------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 7.9 7.7 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT355-1 | | MO-153AD | | | | 93-06-16 95-02-04 |

Octal latched transceiver with dual enable (3-State)

74ABT543A

Data sheet status

| Data sheet status | Product status | Definition [1] |
|---------------------------|----------------|--|
| Objective specification | Development | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice. |
| Preliminary specification | Qualification | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
| Product specification | Production | This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

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